

Dual P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY								
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^{d, e}	Q _g (Typ.)					
- 20	0.040 at V _{GS} = - 4.5 V	- 5.3	17 nC					
	0.045 at V _{GS} = - 2.5 V	- 4.3	17 110					

FEATURES

- Halogen-free
- TrenchFET[®] Power MOSFET
- 100 % UIS Tested

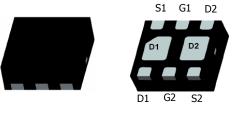
 S_2

 D_2

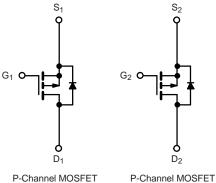
APPLICATIONS

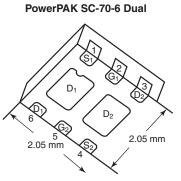
Load Switches





DFN 2x2 Package





ABSOLUTE MAXIMUM RATINGS T	$_{A}$ = 25 °C, unless othe	erwise noted		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	- 20	V
Gate-Source Voltage	V _{GS}	± 12	v	
	T _C = 25 °C		- 5.3 ^e	
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C	l I _D	- 4.8 ^e	
Sommous Drain Surrent (1) = 150 °C)	T _A = 25 °C	טי	- 5.0 ^{a, b}	
	T _A = 70 °C		- 4.7 ^{a, b}	A
Pulsed Drain Current	I _{DM}	- 30 ^e	~	
Continuous Source-Drain Diode Current	T _C = 25 °C	I _S	- 4.1	
Continuous Source-Drain Diode Current	T _A = 25 °C	'S	- 2.0 ^{a, b}	
Avalanche Current	L = 0.1 mH	I _{AS}	- 20	
Single-Pulse Avalanche Energy	L = 0.1 IIIH	E _{AS}	20	mJ
	T _C = 25 °C		5.0	
Movimum Dower Dissinction	T _C = 70 °C	P _D	3.2	w
Maximum Power Dissipation	T _A = 25 °C	'D	2.5 ^{a, b}	vv
	T _A = 70 °C	1	1.6 ^{a, b}	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{a, c}	t ≤ 10 s	R _{thJA}	38	50	°C/W
Maximum Junction-to-Foot	Steady State	R _{thJF}	20	25	0/00

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

c. Maximum under Steady State conditions is 85 °C/W.

d. Based on $T_C = 25$ °C.

e. Limited by package.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \mu A$	- 20			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA		- 31		
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	i _D = - 250 μA		4.5		mV/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 0.3		- 1.0	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zana Cata Maltana Duain Company	1	$V_{DS} = -20 V, V_{GS} = 0 V$			- 1	μA
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 \text{ °C}$			- 5	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge -10 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	- 30			А
		V _{GS} = - 4.5 V,I _D = - 4.3 A		0.040		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 2.5 V, I _D = -4.2 A		0.049		Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 4.1 A		23		S
Dynamic ^b						
Input Capacitance	C _{iss}			1350		
Output Capacitance	C _{oss}	V _{DS} = - 10 V, V _{GS} = 0 V, f = 1 MHz		215		pF
Reverse Transfer Capacitance	C _{rss}			185		
		V _{DS} = - 10 V, V _{GS} = - 10 V, I _D = - 4.1 A		32	50	nC
Total Gate Charge	Qg			15	25	
Gate-Source Charge	Q _{gs}	V _{DS} = - 10 V, V _{GS} = - 4.5 V, I _D = - 4.1 A		4		
Gate-Drain Charge	Q _{gd}			7.5		
Gate Resistance	R _g	f = 1 MHz		5.8		Ω
Turn-On Delay Time	t _{d(on)}			10	15	
Rise Time	t _r	V_{DD} = - 10 V, R _L = 15 Ω		8	15	-
Turn-Off DelayTime	t _{d(off)}	$I_D \cong$ - 1 A, V_{GEN} = - 10 V, R_q = 1 Ω		45	70	
Fall Time	t _f			12	25	
Turn-On Delay Time	t _{d(on)}			42	70	ns
Rise Time	t _r	V_{DD} = - 10 V, R _L = 15 Ω		35	60	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong -1 \text{ A}, \text{ V}_{\text{GEN}} = -4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		40	70	-
Fall Time	t _f			16	30	
Drain-Source Body Diode Characterist						1
Continous Source-Drain Diode Current	۱ _s	T _C = 25 °C			- 4.1	
Pulse Diode Forward Current	I _{SM}	Ŭ Ŭ			- 32	A
Body Diode Voltage	V _{SD}	I _S = - 2 A, V _{GS} = 0 V		- 0.75	- 1.2	V
Body Diode Reverse Recovery Time	t _{rr}			34	60	ns
Body Diode Reverse Recovery Charge	Q _{rr}			22	40	nC
Reverse Recovery Fall Time	t _a	I _F = - 2 A, dl/dt = 100 A/μs, T _J = 25 °C		11		
Reverse Recovery Rise Time	t _b	1		23		ns

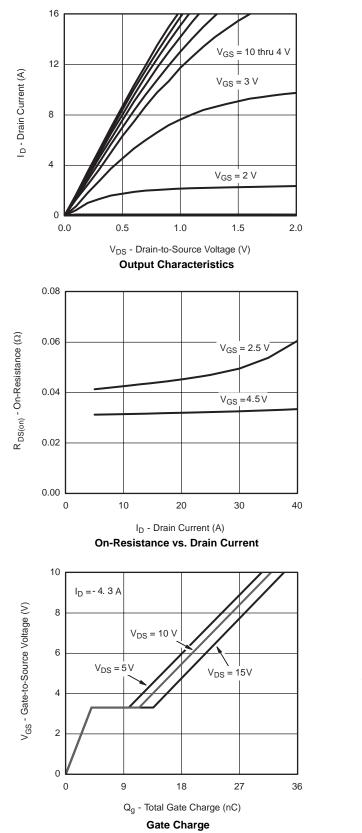
Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

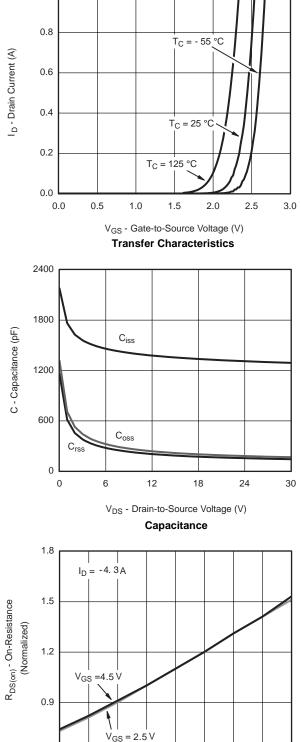
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





TYPICAL CHARACTERISTICS 25 C, unless otherwise noted



1.0

T_J - Junction Temperature (°C) On-Resistance vs. Junction Temperature

50

75

100

125 150

0.6

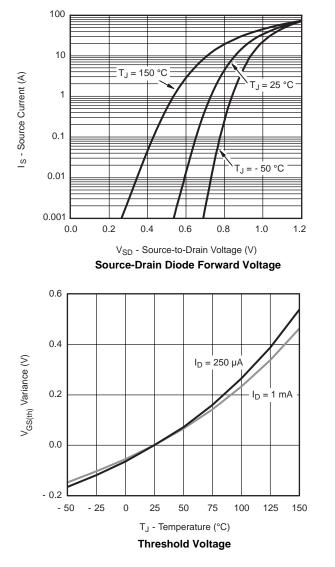
- 50

- 25

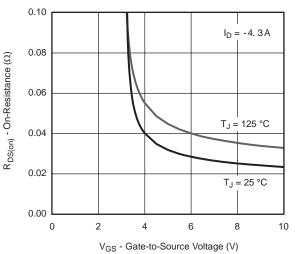
0

25





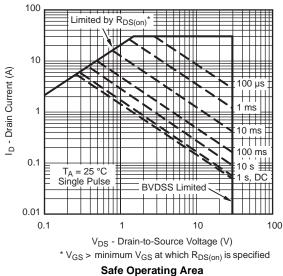
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



On-Resistance vs. Gate-to-Source Voltage

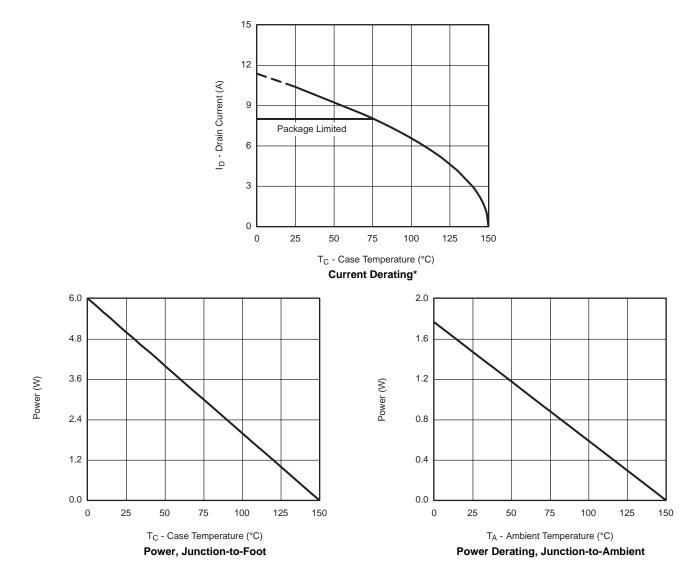


Single Pulse Power, Junction-to-Ambient





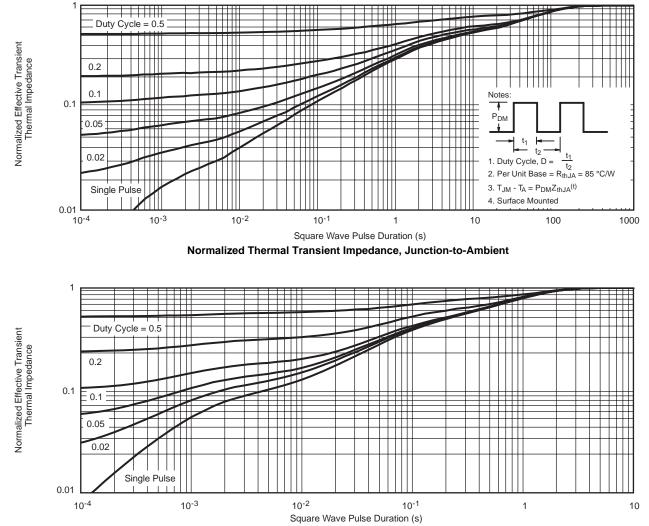
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

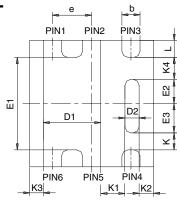


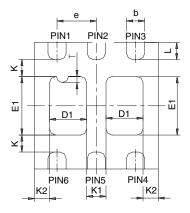
Normalized Thermal Transient Impedance, Junction-to-Foot

VBQG4240



PowerPAK[®] SC70-6L

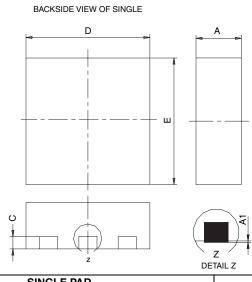




BACKSIDE VIEW OF DUAL



Notes: 1. All dimensions are in millimeters 2. Package outline exclusive of mold flash and metal burr 3. Package outline inclusive of plating



	SINGLE PAD						DUAL PAD					
DIM	М	ILLIMETER	RS	INCHES			MILLIMETERS			INCHES		
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max
Α	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032
A1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002
b	0.23	0.30	0.38	0.009	0.012	0.015	0.23	0.30	0.38	0.009	0.012	0.015
С	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010
D	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
D1	0.85	0.95	1.05	0.033	0.037	0.041	0.513	0.613	0.713	0.020	0.024	0.028
D2	0.135	0.235	0.335	0.005	0.009	0.013						
E	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
E1	1.40	1.50	1.60	0.055	0.059	0.063	0.85	0.95	1.05	0.033	0.037	0.041
E2	0.345	0.395	0.445	0.014	0.016	0.018						
E3	0.425	0.475	0.525	0.017	0.019	0.021						
е		0.65 BSC			0.026 BSC	;	0.65 BSC 0.026 BSC					
К		0.275 TYP			0.011 TYP		0.275 TYP			0.011 TYP		
K1		0.400 TYP			0.016 TYP		0.320 TYP			0.013 TYP		
K2		0.240 TYP			0.009 TYP		0.252 TYP 0.010 TYP					
K3		0.225 TYP		0.009 TYP								
K4		0.355 TYP		0.014 TYP								
L	0.175	0.275	0.375	0.007	0.011	0.015	0.175	0.275	0.375	0.007	0.011	0.015
Т							0.05	0.10	0.15	0.002	0.004	0.006
ECN: C-0 DWG: 59		/. C, 06-Auç	j-07									

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